

SuperMOS – SOT23-3L 60V BV_{DSS}, 1.75Ω R_{DS(on)}, N-channel MOSFET

1. Description

The NDS7002A-ES is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. Device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product NDS7002A-ES is Pb-free.

2. Features

- 60V, R_{DS(ON)}=1.75Ω(TYP.) @V_{GS}=10V
R_{DS(ON)}=2.06Ω(TYP.) @V_{GS}=4.5V
- Use trench MOSFET technology
- High density cell design for low R_{DS(on)}
- Material: Halogen free
- Reliable and rugged
- Avalanche Rated
- Low leakage current

3. Applications

- PWM applications
- Load switch
- Power management in portable/desktop PCs
- DC/DC conversion

4. Ordering Information

Part Number	Package	Marking	Material	Packing	Quantity per reel	Flammability Rating	Reel Size
NDS7002A-ES	SOT23-3L	72KA	Halogen free	Tape & Reel	3,000 PCS	UL 94V-0	7 inches

Table-1 Ordering information

5. Pin Configuration and Functions

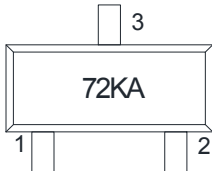
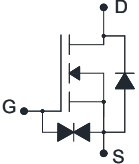
Pin	Function	Outline	Circuit Diagram
1	Gate		
2	Source		
3	Drain		

Table-2 Pin configuration

6. Specification

Absolute Maximum Rating & Thermal Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	BV_{DSS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	$T_A=25^\circ\text{C}$	0.38
		$T_A=100^\circ\text{C}$	0.25
Maximum Power Dissipation	P_D	350	mW
Pulsed Drain Current ^a	I_{DM}	1.5	A
Operating Junction Temperature	T_J	150	°C
Lead Temperature	T_L	260	°C
Storage Temperature Range	T_{stg}	-55 to 150	°C

Thermal resistance ratings

Single Operation			
Parameter	Symbol	Typical	Unit
Junction-to-Ambient Thermal Resistance	$R_{\theta JA}$	300	°C/W

Note:

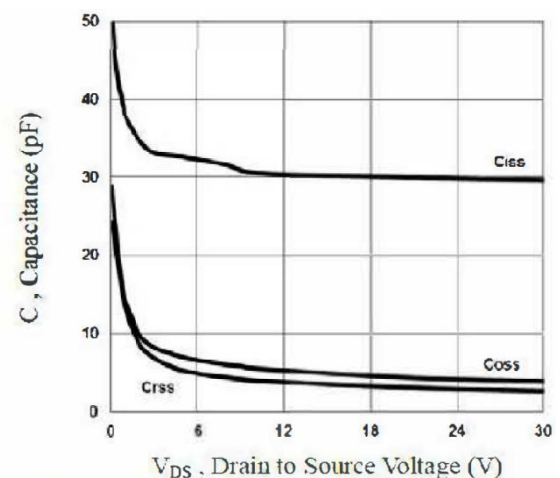
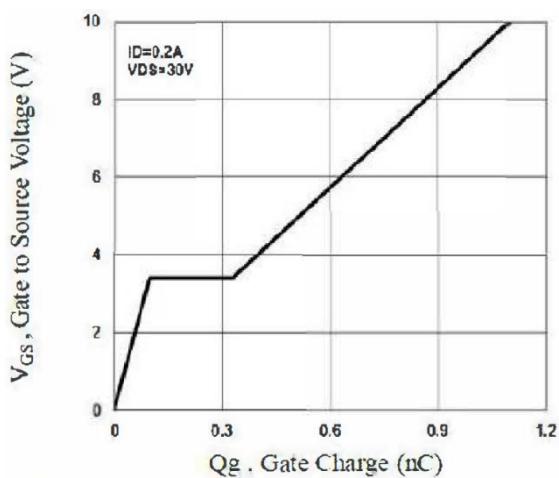
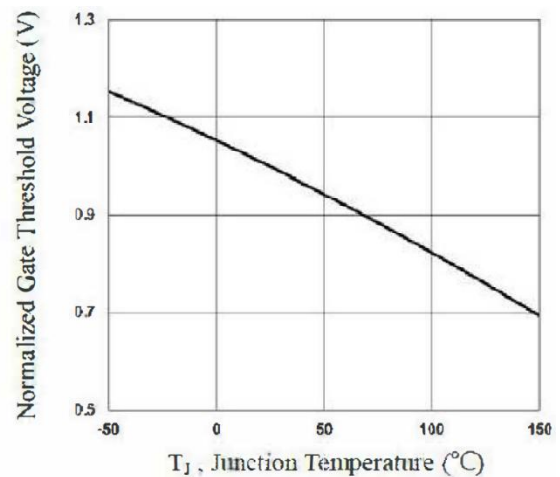
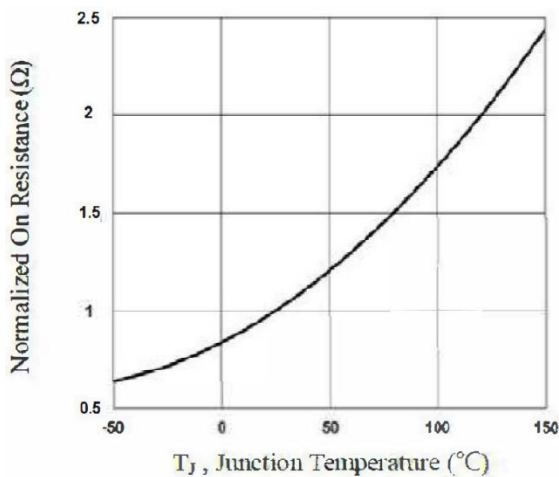
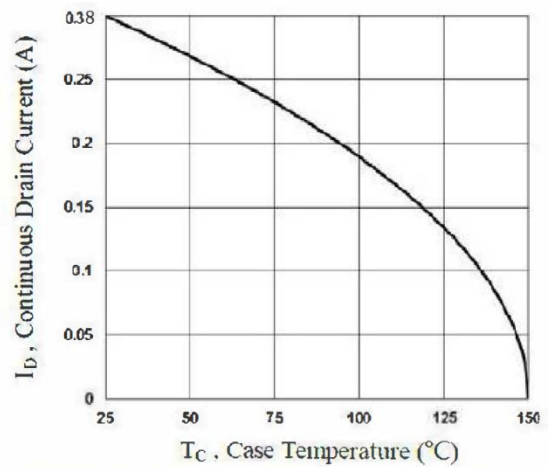
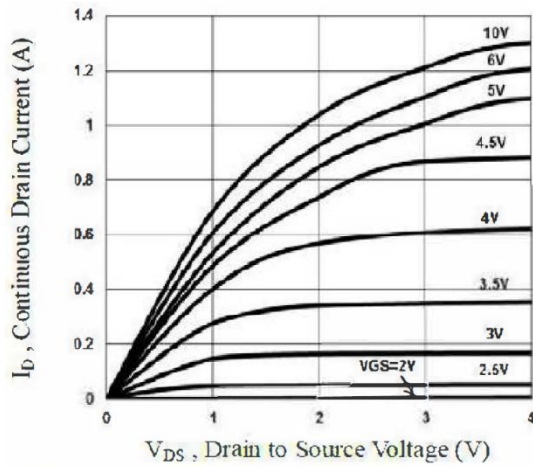
a: Repetitive rating, pulse width limited by junction temperature, $t_p=10\mu\text{s}$, Duty Cycle=1%

Electrical Characteristics

At TA = 25°C unless otherwise specified

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=10mA$	60			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$			1.0	μA
Gate-to-source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 10	μA
Forward Trans conductance	g_{fs}	$V_{DS}=10V, I_D=0.1A$		0.24		S
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	0.8	1.5	2.5	V
Drain-to-source On-resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=0.3A$		1.75	3	Ω
		$V_{GS}=4.5V, I_D=0.2A$		2.06	4	
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C_{ISS}	$V_{GS}=0V, f=1MHz, V_{DS}=10V$		30.5	45	μF
Output Capacitance	C_{OSS}			5.5	10	
Reverse Transfer Capacitance	C_{RSS}			4.1	8	
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS}=10V, V_{DS}=30V, I_D=0.2A$		1.12	2	nC
Gate-to-Source Charge	Q_{GS}			0.1	0.2	
Gate-to-Drain Charge	Q_{GD}			0.23	0.5	
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{d(ON)}$	$V_{GS}=10V, V_{DS}=30V, I_D=0.2A, R_G=6\Omega$		3	6	ns
Rise Time	t_r			5	10	
Turn-Off Delay Time	$t_{d(OFF)}$			14	27	
Fall Time	t_f			9	17	
BODY DIODE CHARACTERISTICS						
Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=1A$			1.5	V

7. Typical Characteristic



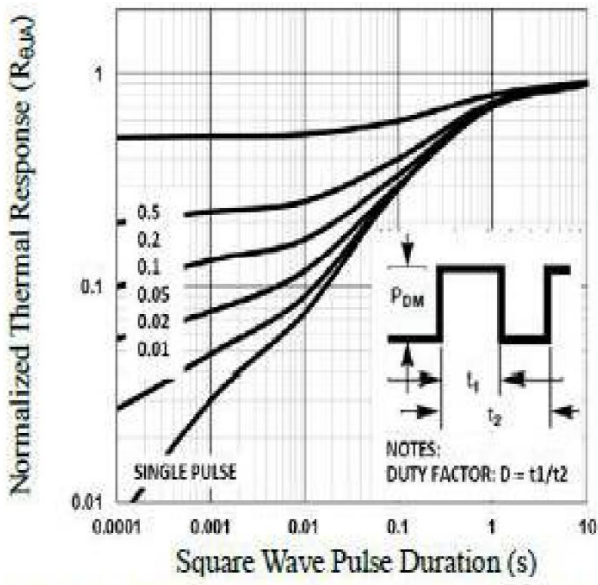


Fig.7 Normalized Transient Impedance

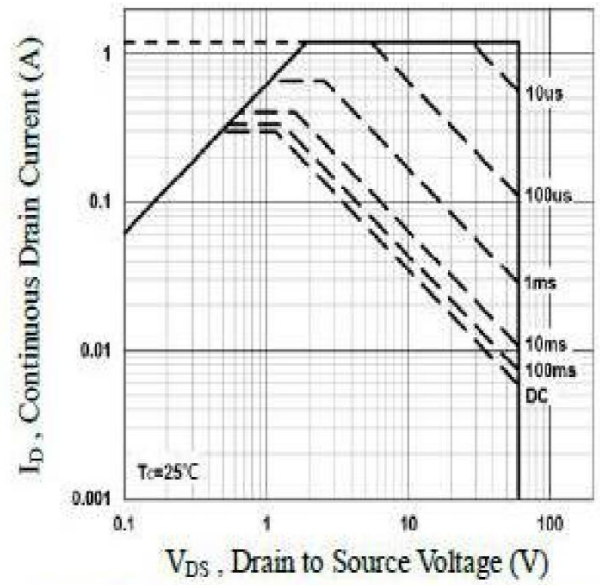
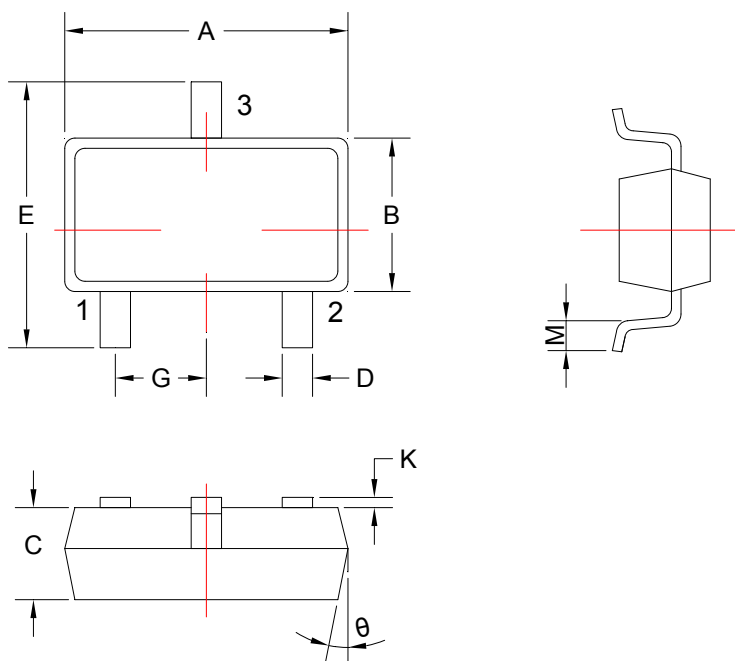


Fig.8 Maximum Safe Operation Area

8. Dimension (SOT23-3L)



COMMON DIMENSIONS CUNITS MEASURE=MILLIMETER					
SYMBOL	MIN	MAX	SYMBOL	MIN	MAX
A	2.82	3.02	G	0.95 TYP	
B	1.50	1.70	K	0	0.10
C	1.05	1.15	M	0.20	-
D	0.30	0.50	θ	7°	11°
E	2.65	2.95			

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